

SPECIFICATIONS

PXIe-4147

PXIe, 4-channel ± 8 V, 3 A PXI Source Measure Unit

Contents

Definitions.....	1
Conditions.....	2
Block Diagrams.....	2
Instrument Capabilities.....	3
Voltage.....	5
Current.....	6
Noise.....	6
Transient Response and Settling Time.....	8
Remote Sense.....	9
Load Regulation.....	9
Isolation.....	9
Protection.....	10
Guard Output Characteristics.....	10
Output Resistance Programming Accuracy.....	10
Measurement and Update Timing.....	11
Triggers.....	12
Physical.....	12
Calibration Interval.....	13
Power Requirements.....	13
Environmental Characteristics.....	13

Definitions

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

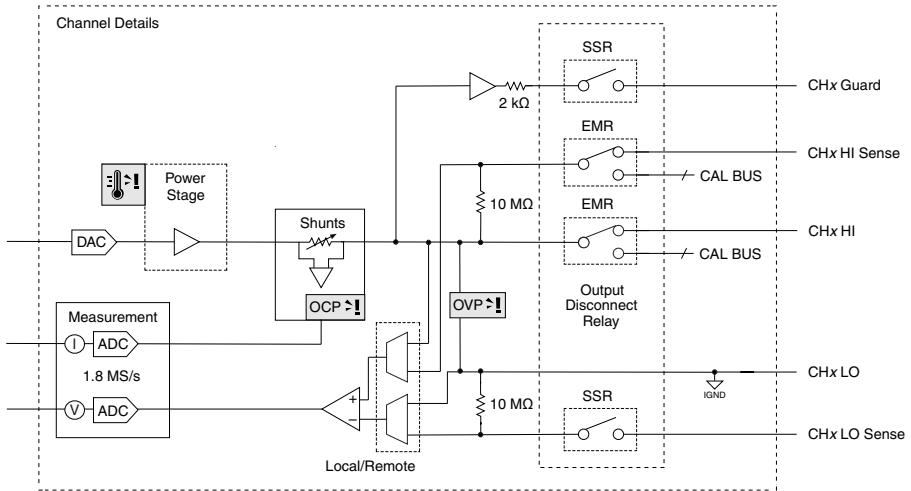
Characteristics describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- *Typical* specifications describe the performance met by a majority of models.
- *Nominal* specifications describe an attribute that is based on design, conformance testing, or supplemental testing.
- *Measured* specifications describe the measured performance of a representative model.

Specifications are *Warranted* unless otherwise noted.



Figure 2. Channel-Level Block Diagram



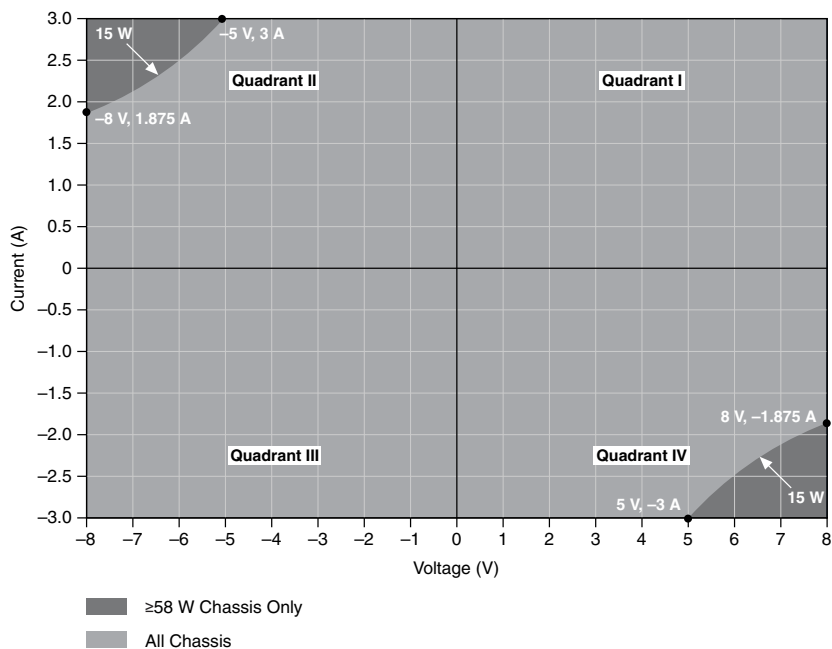
Instrument Capabilities

Channels	0 through 3 ³
DC voltage ranges	1 V, 8 V
DC current ranges	1 μ A, 10 μ A, 100 μ A, 1 mA, 10 mA, 100 mA, 3 A

The following figure illustrates the voltage and the current source and sink ranges of the PXIe-4147.

³ Channels isolated from earth ground, but share a common LO for all channels (bank isolation).

Figure 3. PXIe-4147 Quadrant Diagram, Any Channel



Available DC output power⁴

Sourcing⁵

All chassis

24 W per channel and 40 W total

Sinking

≥58 W Slot Cooling Capacity
Chassis⁶

24 W per channel and 40 W total

<58 W Slot Cooling Capacity
Chassis

15 W per channel and 15 W total

⁴ Power limit defined by voltage measured between HI and LO terminals.

⁵ Sourcing power may be limited by total power available from the chassis power supply. Refer to the [Performing a Power Budget on a PXI/PXIe System](#) article for more information.

⁶ When sinking more than 15 W into the PXIe-4147, transients may not exceed 200 mW/μs.

Voltage

Table 1. Voltage Programming and Measurement Accuracy/Resolution

Range	Resolution (Noise Limited)	Noise (0.1 Hz to 10 Hz, peak-to-peak, typical)	Accuracy \pm (% of Voltage + Offset) ⁷		Tempco ⁸ \pm (% of Voltage + Offset)/°C
			T _{ambient} 23 °C \pm 5 °C, T _{cal} ⁹ \pm 5 °C		
			Multiple Channels ¹⁰	Single Channel ¹¹	T _{ambient} 0 °C to 55 °C, T _{cal} \pm 5 °C
1 V	100 nV	2 μ V	0.025% + 110 μ V	0.02% + 70 μ V	0.0002% + 1 μ V
8 V	1 μ V	12 μ V	0.02% + 600 μ V	0.015% + 400 μ V	

⁷ Refer to the [Remote Sense](#) and [Load Regulation](#) sections for additional accuracy derating and conditions.

⁸ Temperature coefficient applies beyond 23 °C \pm 5 °C ambient within \pm 5 °C of T_{cal}.

⁹ T_{cal} is the internal device temperature recorded by the PXIe-4147 at the completion of the last self-calibration.

¹⁰ Multiple-channel specifications apply whenever two or more channels are connected and sourcing/sinking current. Multiple-channel specifications account for interactions between the channels when operated at high current, including board heating.

¹¹ Single-channel specifications assume only one channel is connected and sourcing/sinking current which results in improved accuracy due to the reduction of effects between the channels, including board heating. When transitioning from a multiple-channel configuration to a single-channel configuration, a ten-minute cool down period is required to meet Single Channel accuracy specifications.

Current

Table 2. Current Programming and Measurement Accuracy/Resolution

Range	Resolution (Noise Limited)	Noise (0.1 Hz to 10 Hz, peak-to-peak, typical)	Accuracy \pm (% of Current + Offset) ¹²		Tempco ⁸ \pm (% of Current + Offset)/°C
			T _{ambient} 23 °C \pm 5 °C, T _{cal} ⁹ \pm 5 °C		T _{ambient} 0 °C to 55 °C, T _{cal} \pm 5 °C
			Multiple Channels ¹⁰	Single Channel ¹¹	
1 μ A	100 fA	8 pA	0.045% + 250 pA	0.035% + 150 pA	0.0003% + 2 pA
10 μ A	1 pA	60 pA	0.05% + 1.6 nA	0.035% + 1 nA	
100 μ A	10 pA	400 pA	0.045% + 14 nA	0.035% + 8 nA	
1 mA	100 pA	4 nA	0.04% + 120 nA	0.03% + 70 nA	
10 mA	1 nA	40 nA	0.04% + 1.2 μ A	0.03% + 700 nA	
100 mA	10 nA	400 nA	0.045% + 12 μ A	0.035% + 7 μ A	
3 A	1 μ A	40 μ A	0.07% + 800 μ A	0.07% + 400 μ A	

Noise

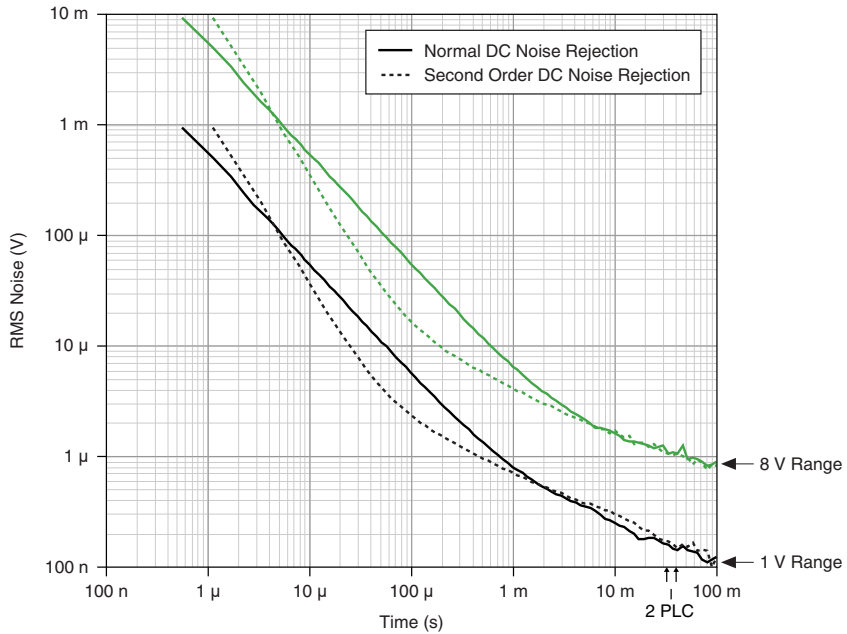
Wideband source noise¹³ <10 mV_{pk-pk}, typical

The following figures illustrate measurement noise as a function of measurement aperture for the PXIe-4147.

¹² Relative humidity between 10% and 70%, noncondensing. When operating above 70% relative humidity, add 30 pA to current accuracy specifications.

¹³ 10 Hz to 20 MHz bandwidth. PXIe-4147 configured for normal transient response.

Figure 4. Voltage RMS Noise Versus Aperture Time, Nominal

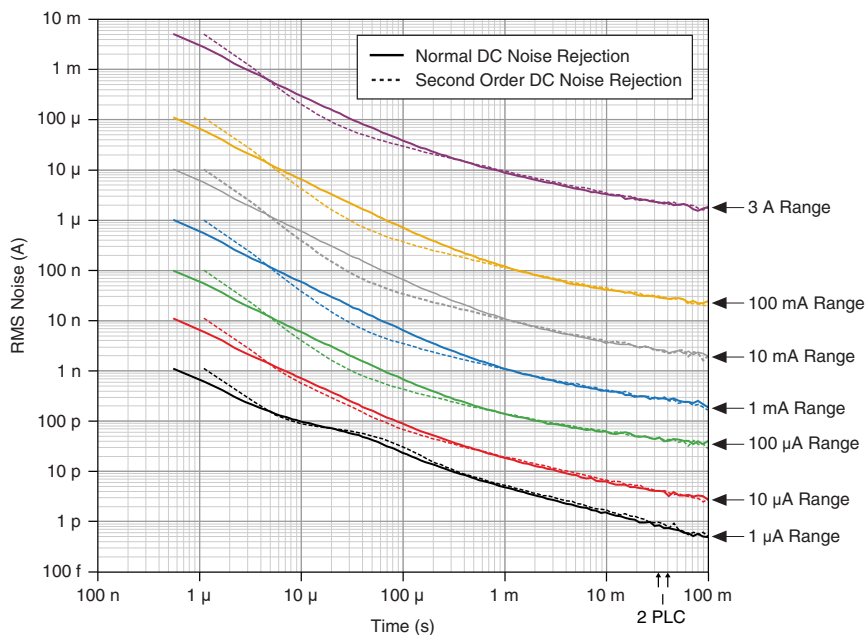


Note When the aperture time is set to two power-line cycles (PLCs), measurement noise differs slightly depending on whether the **niDCPower Power Line Frequency** property or `NIDCPOWER_ATTR_POWER_LINE_FREQUENCY` attribute is set to 50 Hz or 60 Hz.



Note To configure normal or second-order DC noise rejection, set the **niDCPower DC Noise Rejection** property or `NIDCPOWER_ATTR_DC_NOISE_REJECTION` attribute.

Figure 5. Current RMS Noise Versus Aperture Time, Nominal



Note When the aperture time is set to two power-line cycles (PLCs), measurement noise differs slightly depending on whether the **niDCPower Power Line Frequency** property or `NIDCPOWER_ATTR_POWER_LINE_FREQUENCY` attribute is set to 50 Hz or 60 Hz.



Note To configure normal or second-order DC noise rejection, set the **niDCPower DC Noise Rejection** property or `NIDCPOWER_ATTR_DC_NOISE_REJECTION` attribute.

Transient Response and Settling Time

Settling time¹⁴

Voltage mode, ≤ 4 V step, unloaded ¹⁵	< 50 μ s, typical
Current mode, full-scale step, 3 A to 100 μ A ranges ¹⁶	< 50 μ s, typical

¹⁴ Measured as the time to settle to within 0.1% of step amplitude, PXIe-4147 configured for fast transient response.

¹⁵ Current limit set to ≥ 30 μ A and $\geq 20\%$ of the selected current limit range.

¹⁶ Voltage limit set to ≥ 2 V, resistive load set to 1 V/selected current range.

Current mode, full-scale step, 10 μA range ¹⁶	<100 μs , typical
Current mode, full-scale step, 1 μA range ¹⁶	<200 μs , typical
Transient response ¹⁷	
3 A to 100 μA ranges	<40 μs , typical
10 μA range	<100 μs , typical
1 μA range	<200 μs , typical

Remote Sense

Voltage accuracy	Add (10 ppm of voltage range + 25 μV) per volt of LO lead drop, plus 10 μV per volt of HI lead drop to voltage accuracy specification
Maximum sense lead resistance	100 Ω
Maximum lead drop per lead	1 V, maximum 8 V between HI and LO terminals

Load Regulation

Voltage, local sense ¹⁸	100 $\mu\text{V}/\text{mA}$, nominal; 200 $\mu\text{V}/\text{mA}$, maximum
Voltage, remote sense	Error included in accuracy specifications.
Current	Error included in accuracy specifications.

Isolation

Isolation voltage, any pin to earth ground ¹⁹	60 V DC, CAT I
Withstand voltage	800 V_{pk}

¹⁷ Time to recover within 10 mV after a load current change from 10% to 90% of range, PXIe-4147 configured for fast transient response.

¹⁸ At the output terminals of attached TB-414X Screw Terminal Connector Kit.

¹⁹ Channels isolated from earth ground, but share a common LO for all channels (bank isolation).

Protection

Absolute maximum voltage to Output LO, all pins

Output HI	$\pm 10\text{ V}$
All other pins	$\pm 60\text{ V}$

Output channel protection

Overcurrent or overvoltage	Automatic shutdown, output disconnect relay opens
Overtemperature	Automatic shutdown, output disconnect relay opens

Guard Output Characteristics

Cable guard

Output impedance	$2\text{ k}\Omega$, nominal
Offset voltage	1 mV , typical

Output Resistance Programming Accuracy

Table 3. Output Resistance Programming Accuracy

Current Level/ Limit Range	Voltage Mode		Current Mode	
	Programmable Resistance Range	Accuracy, \pm (% of Resistance Setting + Offset) ²⁰	Programmable Resistance Range	Accuracy, \pm (% of resistance setting Offset) ²⁰
$1\text{ }\mu\text{A}$	0 to $\pm 4\text{ M}\Omega$	$0.05\% + 100\text{ }\Omega$	$\pm 2.5\text{ M}\Omega$ to $\pm\text{infinity}$	$0.05\% \parallel 100\text{ G}\Omega$
$10\text{ }\mu\text{A}$	0 to $\pm 400\text{ k}\Omega$	$0.05\% + 10\text{ }\Omega$	$\pm 250\text{ k}\Omega$ to $\pm\text{infinity}$	$0.05\% \parallel 10\text{ G}\Omega$
$100\text{ }\mu\text{A}$	0 to $\pm 40\text{ k}\Omega$	$0.05\% + 1\text{ }\Omega$	$\pm 25\text{ k}\Omega$ to $\pm\text{infinity}$	$0.05\% \parallel 1\text{ G}\Omega$
1 mA	0 to $\pm 4\text{ k}\Omega$	$0.05\% + 100\text{ m}\Omega$	$\pm 2.5\text{ k}\Omega$ to $\pm\text{infinity}$	$0.05\% \parallel 100\text{ M}\Omega$

²⁰ Accuracy is typical and applies within $\pm 5\text{ }^\circ\text{C}$ of last self calibration.

Table 3. Output Resistance Programming Accuracy (Continued)

Current Level/ Limit Range	Voltage Mode		Current Mode	
	Programmable Resistance Range	Accuracy, \pm (% of Resistance Setting + Offset) ²⁰	Programmable Resistance Range	Accuracy, \pm (% of resistance setting Offset) ²⁰
10 mA	0 to $\pm 400\ \Omega$	$0.05\% + 10\ \text{m}\Omega$	$\pm 250\ \Omega$ to $\pm\text{infinity}$	$0.05\% \parallel 10\ \text{M}\Omega$
100 mA	0 to $\pm 40\ \Omega$	$0.05\% + 1\ \text{m}\Omega$	$\pm 25\ \Omega$ to $\pm\text{infinity}$	$0.05\% \parallel 1\ \text{M}\Omega$
3 A	0 to $\pm 1.25\ \Omega$	$0.08\% + 100\ \mu\Omega$	$\pm 750\ \text{m}\Omega$ to $\pm\text{infinity}$	$0.08\% \parallel 10\ \text{k}\Omega$

Measurement and Update Timing

Available sample rates²¹ (1.8 MS/s)/ N , nominal

where

$$N = 1, 2, 3, \dots 2^{24}$$

S is samples

Sample rate accuracy Equal to PXIe_CLK100 accuracy, nominal

Maximum measure rate to host 1.8 MS/s per channel, continuous, nominal

Maximum source update rate²² 100,000 updates/s, nominal

Input trigger to

Source event delay 10 μs , nominal

Source event jitter 2 $\mu\text{s}_{\text{pk-pk}}$, nominal

Measure event jitter 2 $\mu\text{s}_{\text{pk-pk}}$, nominal

²⁰ Accuracy is typical and applies within $\pm 5\ ^\circ\text{C}$ of last self calibration.

²¹ When source-measuring, both the NI-DCPower **Source Delay** and **Aperture Time** properties affect the sampling rate. When taking a measure record, only the **Aperture Time** property affects the sampling rate.

²² As the source delay is adjusted or if advanced sequencing is used, maximum source update rates may vary.

Triggers

Input triggers

Types	Start Source Sequence Advance Measure
Sources (PXI trigger lines 0 to 7) ²³	
Polarity	Active high (not configurable)
Minimum pulse width	100 ns
Destinations ²⁴ (PXI trigger lines 0 to 7) ²³	
Polarity	Active high (not configurable)
Minimum pulse width	>200 ns
Output triggers (events)	
Types	Source Complete Sequence Iteration Complete Sequence Engine Done Measure Complete
Destinations (PXI trigger lines 0 to 7) ²³	
Polarity	Active high (not configurable)
Pulse width	230 ns

Physical

Dimensions	3U, one-slot, PXI Express/CompactPCI Express module 2.0 cm × 13.0 cm × 21.6 cm (0.8 in. × 5.1 in. × 8.5 in.)
Weight	448 g (15.8 oz)
Front panel connectors	25-position D-SUB, male

²³ Pulse widths and logic levels are compliant with *PXI Express Hardware Specification Revision 1.0 ECN 1*.

²⁴ Input triggers can come from any source (PXI trigger or software trigger) and be exported to any PXI trigger line. This allows for easier multi-board synchronization regardless of the trigger source.

Calibration Interval

Recommended calibration interval	1 year
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Power Requirements

+3.3 V	1 A, typical
+12 V	1.3 A, typical at idle; 6 A, maximum at full load

Environmental Characteristics

Temperature and Humidity

Temperature	
Operating	0 °C to 55 °C ²⁵
Storage	-40 °C to 71 °C
Humidity	
Operating	10% to 90%, noncondensing ²⁶
Storage	5% to 95%, noncondensing
Pollution Degree	2
Maximum altitude	2,000 m (800 mbar) (at 25 °C ambient temperature)

²⁵ Not all chassis can achieve this ambient temperature range. Refer to PXI chassis specifications to determine the ambient temperature ranges your chassis can achieve.

²⁶ When transitioning a device from a storage or operation environment with relative humidity above 70%, device should be allowed to stabilize in the lower humidity environment for several hours before use. Refer to the PXIe-4147 *Programming and Measurement Accuracy/Resolution* specifications for additional performance derating when operating above 70% relative humidity.

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